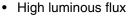


TELUXTM

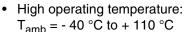




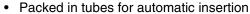


FEATURES









- Luminous flux, forward voltage and color categorized for each tube
- Small mechanical tolerances allow precise usage of external reflectors or lightguides
- · Lead (Pb)-free device
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC
- ESD-withstand voltage: up to 2 kV according to JESD22-A114-B
- Compatible with wave solder processes acc. to CECC 00802 and J-STD-020C
- · Automotive qualified

APPLICATIONS

- Exterior lighting
- Tail-, stop and turn signals of motor vehicles
- Replaces small incandescent lamps
- · Traffic signals and signs

PRODUCT GROUP AND PACKAGE DATA

Product group: LED
 Package: TELUX™
 Product series: power

Froduct Series, power

· Angle of half intensity: see parts table

DESCRIPTION

The TELUX™ series is a clear, non diffused LED for applications where supreme luminous flux is required. It is designed in an industry standard 7.62 mm square package utilizing highly developed with super bright, AllnGaP technology.

The supreme heat dissipation of TELUX™ allows applications at high ambient temperatures.

All packing units are binned for luminous flux, forward voltage and color to achieve the most homogenous light appearance in application.

SAE and ECE color requirements for automobile application are available for color red.

PARTS TABLE				
PART	COLOR, LUMINOUS FLUX	ANGLE OF HALF INTENSITY (± φ)	TECHNOLOGY	
VLWR9430	Red, $\phi_V > 5000 \text{ m/m}$	25 x 68	AllnGaP on Si	
VLWR9530	Red, $\phi_V > 5000 \text{ m/m}$	40 x 90	AllnGaP on Si	



ABSOLUTE MAXIMUM RATINGS 1) VLWR9.3.				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage ²⁾	I _R = 100 μA	V _R	10	V
DC Forward current	T _{amb} ≤ 85 °C	I _F	70	mA
Surge forward current	t _p ≤ 10 μs	I _{FSM}	0.1	Α
Power dissipation		P _V	212	mW
Junction temperature		T _j	125	°C
Operating temperature range		T _{amb}	- 40 to + 110	°C
Storage temperature range		T _{stg}	- 55 to + 110	°C
Soldering temperature	t ≤ 5 s, 1.5 mm from body preheat temperature 100 °C/ 30 s	T _{sd}	260	°C
Thermal resistance junction/ ambient	with cathode heatsink of 70 mm ²	R _{thJA}	200	K/W
Thermal resistance junction/pin		R_{thJP}	90	K/W

Note:

 ¹⁾ T_{amb} = 25 °C, unless otherwise specified
 2) Driving the LED in reverse direction is suitable for a short term application

OPTICAL AND ELECTRICAL CHARACTERISTICS 1) VLWR9.3., RED							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Total flux	I _F = 70 mA, R _{thJA} = 200 °K/W	VLWR9430	φV	5000	6000		mlm
		VLWR9530	φ _V	5000	6000		mlm
Dominant wavelength	$I_F = 70 \text{ mA}, R_{thJA} = 200 \text{ °K/W}$		λ_{d}	611	615	634	nm
Peak wavelength	$I_F = 70 \text{ mA}, R_{thJA} = 200 \text{ °K/W}$		λ_{p}		624		nm
America of half interacts.	I _F = 70 mA, R _{th.IA} = 200 °K/W	VLWR9430	φ		25 x 68		deg
Angle of half intensity	if = 70 mA, rithJA = 200 1000	VLWR9530	φ		40 x 90		deg
Forward voltage	$I_F = 70 \text{ mA}, R_{thJA} = 200 \text{ °K/W}$		V _F	1.83	2.4	3.03	V
Reverse voltage			V _R	10	20		V
Temperature coefficient $< \lambda_d$	I _F = 70 mA		TCλ _d		0.05		nm/K
Temperature coefficient V _F	I _F = 70 mA, T > - 25 °C		TC _{VF}		- 2.0		mV/K

 $^{^{1)}}$ T_{amb} = 25 °C, unless otherwise specified

FORWARD VOLTAGE CLASSIFICATION			
GROUP	FORWARD	VOLTAGE (V)	
GROUP	MIN.	MAX.	
Υ	1.83	2.07	
Z	1.95	2.19	
0	2.07	2.31	
1	2.19	2.43	
2	2.31	2.55	
3	2.43	2.67	
4	2.55	2.79	
5	2.67	2.91	
6	2.79	3.03	



LUMINOUS FLUX CLASSIFICATION			
GROUP	LUMINOUS	FLUX (mlm)	
GROUP	MIN.	MAX.	
I	5000	7300	
K	6000	9700	
L	7000	12 200	

NI	nt.	\sim

Luminous flux is tested at a current pulse duration of 25 ms and an accuracy of \pm 11 %.

The above type numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each tube (there will be no mixing of two groups on each tube).

In order to ensure availability, single brightness groups will be not orderable.

In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped in any one tube.

In order to ensure availability, single wavelength groups will not be orderable.

TYPICAL CHARACTERISTICS

T_{amb} = 25 °C, unless otherwise specified

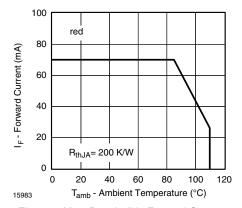


Figure 1. Max. Permissible Forward Current vs.
Ambient Temperature

COLOR CLASSIFICATION			
DOMINANT WAVELENGTH (n			
GROUP	MIN.	MAX.	
1	611	618	
2	614	622	
3	616	634	

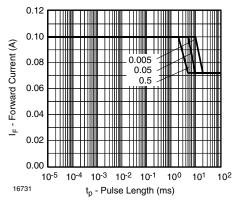


Figure 2. Permissible Forward Current vs. Pulse Length



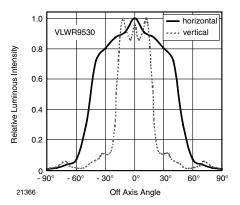


Figure 3. Rel. Luminous Intensity vs. Off Axis

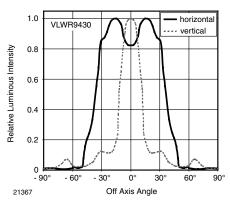


Figure 4. Rel. Luminous Intensity vs. Off Axis

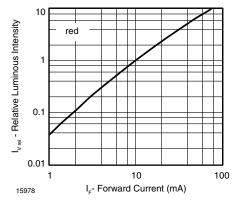


Figure 5. Relative Luminous Flux vs. Forward Current

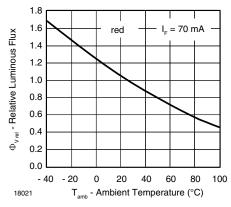


Figure 6. Rel. Luminous Flux vs. Ambient Temperature

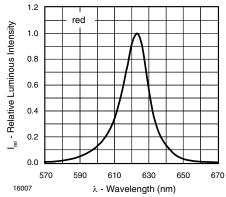


Figure 7. Relative Intensity vs. Wavelength

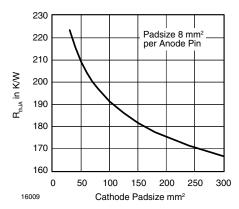
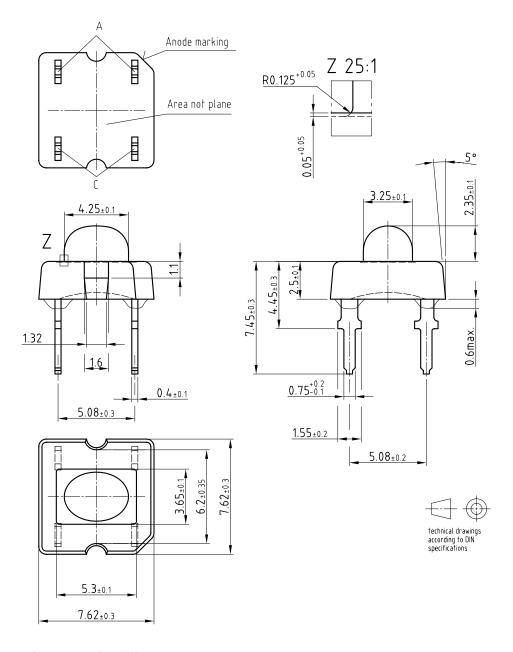


Figure 8. Thermal Resistance Junction Ambient vs.
Cathode Padsize



PACKAGE DIMENSIONS in millimeters **FOR VLWR9430**



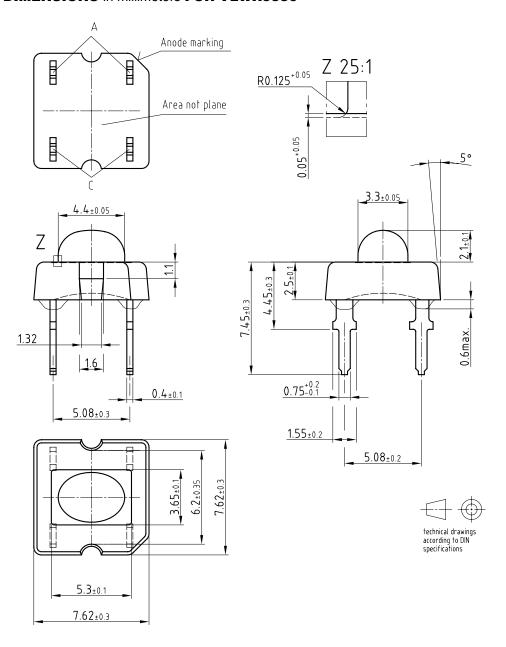
Drawing-No.: 6.544-5395.01-4

Issue: 1; 14.05.08

21364

VISHAY.

PACKAGE DIMENSIONS in millimeters **FOR VLWR9530**

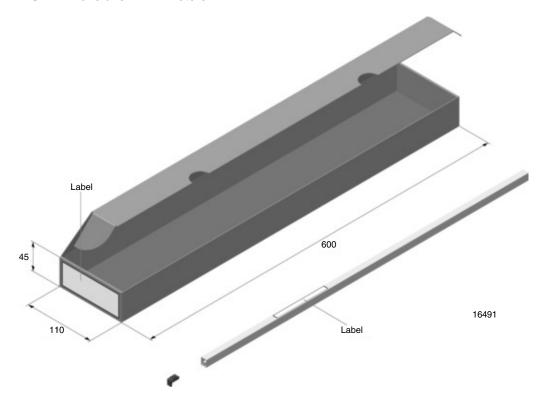


Drawing-No.: 6.544-5395.02-4

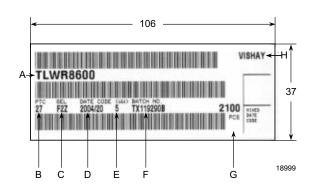
Issue: 1; 14.05.08

21365

FAN FOLD BOX Dimensions in millimeters



LABEL OF FAN FOLD BOX

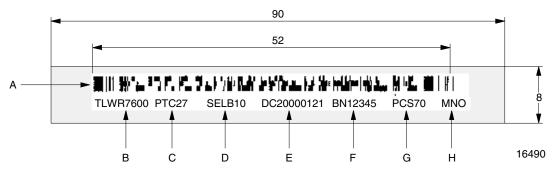


- A) Type of component
- B) Manufacturing plant
- C) SEL selection code (bin):
 Digit 1- code for luminous flux group
 Digit 2- code for dominant wavelength group
 Digit 3- code for forward voltage group
- D) Date code year/week
- E) Day code (e.g. 5: Friday)
- F) Batch no.
- G) Total quantity
- H) Company code

Note: Any distance between bar code and character is more than 1 mm.

VISHAY.

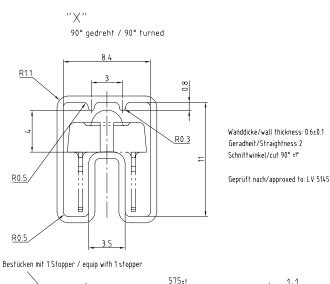
EXAMPLE FOR TELUX TUBE LABEL Dimensions in millimeters

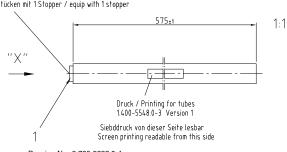


- A) Bar code
- B) Type of component
- C) Manufacturing plant
- D) SEL selection code (bin):
 - Digit 1 code for luminous flux group
 - Digit 2 code for dominant wavelength group
 - Digit 3 code for forward voltage group
- E) Date code

- F) Batch no.
- G) Total quantity
- H) Company code

TUBE WITH BAR CODE LABEL Dimensions in millimeters





Drawing-No.: 9.700-5223.0-4 Rev. 2; Date: 23.08.99

Figure 9. Drawing Proportions not scaled

VLWR9430/VLWR9530



Vishay Semiconductors

OZONE DEPLETING SUBSTANCES POLICY STATEMENT

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA.
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany

Document Number 81888 Rev. 1.0, 20-May-08



Vishay

Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Document Number: 91000 Revision: 18-Jul-08